ASSOCIATION CONN ELECTRONICS INDU	Material Composit © Copyright 2005. IPC, 1 International and Pan-An	Bannockb	urn. Illinois. A	ll rights reserved untions.	under both	This docum level parts,	ent is a declar the declaratio	ration of n encon	of the substance mpasses all low	es within the manu ver level materials	afacturer l for whicl	listed item. Note: h the manufacture	if the item is an a r has engineering	ssembly with lower responsibility.		
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribu				Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater 					Materials	ials and Mfg Information				
Supplier Inf	formation															
Company name*			Company unique ID			Unique ID Authority					Response Date*					
onsemi											2023-06-08					
Contact Name		Title - Contact			Phone - Contact*				E	Email - Contact*						
Product-Env-Stewards			Product Enviro Compliance			NA				Р	Product-Env-Stewards@onsemi.com					
Authorized Representative*			Title - Representative			Phone - Representative*				E	Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			NA				Р	Product-Env-Stewards@onsemi.com					
Req	uester Item Number	Mfr Item	m Number Mfr Item Name				Effective Date	ate V	resion	n Manufacturing Site		Weight*	UOM	Unit Type		
		LA6585FA-BH		1PH DRV SENSOR NA ; Single phase driver with hall sensor method (no speed control)			2023-06-08			31.12	mg	Each				
Manufacturi	ing Proccess Information	l														
Term	Terminal Plating / Grid Array Material			erminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperature Max		ure Max Time a	t Peak Tei	k Temperature Number of Reflow Cycles		vcles			
Matt	te Tin (Sn) - annealed	U Alloy	Alloy 1			260 C 30				seconds 3						
Comments																
evel 1 - maxim	um time at peak temperature d	luring sol	dering is 10-3	0 seconds												
for more inform	mation regarding material com	position]	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth							
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Company will rely on this certification in determining the complance of its products with European Union member studies that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier remet with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for suses that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's liability and the Company's remedies for uses that arise regarding information the Supplier provides in this form. In the											
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.11	mg	Supplier	Silicon (Si)	7440-21-3		2.1022	mg
			Supplier	Polyimide	Proprietary Data		0.0078	mg
Die Attach	0.18	mg	Supplier	Silver (Ag)	7440-22-4		0.135	mg
			Supplier	Epoxy resins	129915-35-1		0.045	mg
Lead Frame	14.28	mg	Supplier	Silver (Ag)	7440-22-4		0.357	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0143	mg
			Supplier	Iron (Fe)	7439-89-6		0.3413	mg
			Supplier	Copper (Cu)	7440-50-8		13.5674	mg
Mold Compound-Black	13.87	mg		Epoxy Phenol Resin	proprietary data		1.4563	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.4136	mg
Plating	0.38	mg	Supplier	Tin (Sn)	7440-31-5		0.38	mg
Wire Bond - Au	0.3	mg	Supplier	Gold (Au)	7440-57-5		0.3	mg